

Amendments to the Claims

1. (CURRENTLY AMENDED) A module ~~(3)~~ for a data carrier ~~(1)~~, which module (3) includes an integrated component (4) with at least two connection contacts ~~(5, 6)~~ and, for each connection contact ~~(5, 6)~~, a connecting part ~~(7, 8)~~ which is electrically conductively connected to the relevant connection contact ~~(5, 6)~~, the connection contacts ~~(5, 6)~~ being constructed so as to project from the integrated component (4) and the connecting parts ~~(7, 8)~~ consisting of metal and being constructed so as to be plate-shaped, the connecting parts ~~(7, 8)~~ comprising remnants ~~(11)~~ of raised portions which have been formed by mechanical deformation of the connecting parts ~~(7, 8)~~, which remnants ~~(11)~~ project from the connecting parts ~~(7, 8)~~ in the direction of the connection contacts ~~(5, 6)~~.

2. (CURRENTLY AMENDED) A module ~~(3)~~ as claimed in claim 1, in which the remnants ~~(11)~~ of raised portions originate from raised portions formed by stamping.

3. (CURRENTLY AMENDED) A module ~~(3)~~ as claimed in claim 1, in which the remnants ~~(11)~~ of raised portions have a height of between 1.0 μm and 10 μm .

4. (CURRENTLY AMENDED) A module ~~(3)~~ as claimed in claim 1, in which the remnants ~~(11)~~ of raised portions have a lateral length of between 10 μm and 50 μm in the transitional zone to the connecting parts ~~(7, 8)~~.

5. (CURRENTLY AMENDED) A module ~~(3)~~ as claimed in claim 1, in which a filler material ~~(12)~~ which encloses the connection contacts ~~(5, 6)~~ and the remnants ~~(11)~~ of raised portions is provided between the integrated component (4) and the connecting parts ~~(7, 8)~~.

6. (CURRENTLY AMENDED) A module ~~(3)~~ as claimed in claim 5, in which the filler material ~~(12)~~ is formed by a foil which consists of a synthetic material and can be softened at least once by heating.

7. (CURRENTLY AMENDED) A data carrier ~~(1)~~ provided with a module ~~(3)~~ which includes an integrated component ~~(4)~~ with at least two connection contacts ~~(5, 6)~~ and, for each connection contact ~~(5, 6)~~, a connecting part ~~(7, 8)~~ which is electrically conductively connected to the relevant connection contact ~~(5, 6)~~, the connection contacts ~~(5, 6)~~ being constructed so as to project from the integrated component ~~(4)~~ and the connecting parts ~~(7, 8)~~ consisting of metal and being constructed so as to be plate-shaped, the connecting parts ~~(7, 8)~~ comprising remnants ~~(11)~~ of raised portions which have been formed by mechanical deformation of the connecting parts ~~(7, 8)~~, which remnants ~~(11)~~ project from the connecting parts ~~(7, 8)~~ in the direction of the connection contacts ~~(5, 6)~~.

8. (CURRENTLY AMENDED) A data carrier ~~(1)~~ as claimed in claim 7, in which the remnants ~~(11)~~ of raised portions originate from raised portions formed by stamping.

9. (CURRENTLY AMENDED) A data carrier ~~(1)~~ as claimed in claim 7, in which the remnants ~~(11)~~ of raised portions have a height of between 1.0 μm and 10 μm .

10. (CURRENTLY AMENDED) A data carrier ~~(1)~~ as claimed in claim 7, in which the remnants ~~(11)~~ of raised portions have a lateral length of between 10 μm and 50 μm in the transitional zone to the connecting parts ~~(7, 8)~~.

11. (CURRENTLY AMENDED) A data carrier ~~(1)~~ as claimed in claim 7, in which a filler material ~~(12)~~ which encloses the connection contacts ~~(5, 6)~~ and the remnants ~~(11)~~ of raised portions is provided between the integrated component ~~(4)~~ and the connecting parts ~~(7, 8)~~.

12. (CURRENTLY AMENDED) A data carrier ~~(1)~~ as claimed in claim 11, in which the filler material ~~(12)~~ is formed by a foil which consists of a synthetic material and can be softened at least once by heating.